

 ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®		Material Composition Declaration © Copyright 2005, IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.				
1752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x		Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information			
Supplier Information									
Company name* onsemi			Company unique ID		Unique ID Authority		Response Date* 2026-10-12		
Contact Name Product-Env-Stewards			Title - Contact Product Enviro Compliance		Phone - Contact* NA		Email - Contact* Product-Env-Stewards@onsemi.com		
Authorized Representative* Product-Env-Stewards			Title - Representative Product Enviro Compliance		Phone - Representative* NA		Email - Representative* Product-Env-Stewards@onsemi.com		
	Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type
		E7160-0-102A57-BPG	EZAIRO 7160 SL	2026-10-12		CA1	74.0	mg	Each
Manufacturing Process Information									
	Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles			
	SnAgCu	CU Alloy	3	240	C	30	seconds	3	
Comments									
ATTENTION: MSL 3 Rated item requires Bake and Dry Pack (after electrical test)									
For more information regarding material composition please refer to page 3									

RoHS Material Composition Declaration		Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).		
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a “RoHS restricted substance”) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier’s liability and the Company’s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.			
RoHS Declaration *	1 - Item(s) does not contain RoHS restricted substances per the definition above		Supplier Acceptance * Accepted
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.			
Exemption List Version	EL-2011/534/EU		
Declaration Signature			
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.			
Supplier Digital Signature	Rastislav Drska		

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Capacitor	4.29	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.8244	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.0215	mg
			Supplier	Tin (Sn)	7440-31-5		0.2673	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.086	mg
			Supplier	Misc.	Proprietary Data		0.2748	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		1.6489	mg
			B	Nickel (Ni)	7440-02-0		0.199	mg
			Supplier	Copper (Cu)	7440-50-8		0.968	mg
Die	9.487651	mg	Supplier	Silicon (Si)	7440-21-3		9.4877	mg
Laminate Board	25.159492	mg	Supplier	Tetraamminepalladium (II) dichloride	13818-17-3		0.0018	mg
			Supplier	triethylenediamine	280-57-9		0.0015	mg
			Supplier	Sodium citrate	68-04-2		0	mg
			Supplier	D.I. Water	7732-18-5		0.1056	mg
			Supplier	Nickel Sulfamate	13770-89-3		0.1677	mg
			Supplier	copper	7440-66-6		11.843	mg
			Supplier	copper foil	N/A		0.3184	mg
			Supplier	continuous filament fiber glass	N/A		2.8842	mg
			Supplier	Defoamers	N/A		0.1269	mg
			Supplier	Phthalocyanine blue	N/A		0.0181	mg
			Supplier	Organic Filler	N/A		0.0218	mg
			Supplier	Acrylate resin	N/A		1.2766	mg
			Supplier	Dipropyleneglycolmonomethylether	34590-97-8		0.272	mg
			Supplier	Gold Potassium Cyanide	13967-50-5		0.0152	mg
			Supplier	Thermosetting resin	Proprietary Data		4.595	mg
			Supplier	Cured Thermosetting Resin	Proprietary Data		0.9573	mg
			Supplier	Silica	Proprietary Data		0.0254	mg
			Supplier	Talc	14807-96-6		0.0762	mg
			Supplier	3-methoxy-3-methylbutylacetate	103429-90-9		0.5621	mg
			Supplier	Naphthalene	91-20-3		0.0254	mg
			Supplier	Photoinitiator	Proprietary Data		0.1305	mg
			Supplier	Palladium (Pd)	7440-05-3		0	mg
			B	Nickel (Ni)	7440-02-0		0.0001	mg

			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5		0.1305	mg
			Supplier	Copper (Cu)	7440-50-8		0.6423	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7		0.9613	mg
Mold Compound-Black	31.761658	mg		Epoxy resin	proprietary data		2.5409	mg
			Supplier	Phenol Resin	Proprietary Data		1.5881	mg
			Supplier	Metal Hydroxide	Proprietary Data		0.3176	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		7.9404	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3176	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		19.057	mg
Solder Paste	2.64	mg	Supplier	2-(2-Hexyloxyethoxy) ethanol	112-59-4		0.1056	mg
			Supplier	Denatured Acid Hydrogenation Rosin	Proprietary		0.1056	mg
			Supplier	Dimer Acid	Proprietary		0.0528	mg
			Supplier	Silver (Ag)	7440-22-4		0.0792	mg
			Supplier	Tin (Sn)	7440-31-5		2.2704	mg
			Supplier	Copper (Cu)	7440-50-8		0.0264	mg
Wire Bond - Au	0.6612	mg	Supplier	Gold (Au)	7440-57-5		0.6612	mg